AMENDMENTS TO THE CLAIMS

- (Original) A method, comprising:
 exciting an undesirable bond in an atomic layer deposition (ALD) formed film to an
 energy level greater than a ground state of the undesirable bond.
- 2. (Original) The method of claim 1, further comprising: after exciting the undesirable bond, exposing the film to a reactant.
- 3. (Original) The method of claim 2, wherein the reactant is an oxygen source.
- 4. (Original) The method of claim 3, wherein the oxygen source is water.
- 5. (Original) The method of claim 2, wherein the reactant comprises a metal precursor.
- 6. (Original) The method of claim 5, wherein the metal is one of zirconium, titanium, aluminum, gallium, cesium, indium, hafnium, tantalum, praseodymium, niobium, scandium, lutetium, cerium and lanthanum.
- 7. (Original) The method of claim 1, wherein the undesirable bonds are metal-metal bonds.
- 8. (Original) The method of claim 7, wherein the metal is selected from a group consisting of zirconium, titanium, aluminum, gallium, cesium, indium, hafnium, tantalum, praseodymium, niobium, scandium, lutetium, cerium and lanthanum.
- 9. (Original) The method of claim 1, wherein the film is a metal oxide film.
- 10. (Original) The method of claim 1, wherein exciting the undesirable bonds comprises exposing the undesirable bonds to electromagnetic radiation.

11. (Withdrawn) A method, comprising:

forming a film on a substrate, wherein forming the film comprises:

exposing the substrate to a reactant to form hydroxyl bonds on a surface of the substrate;

exposing the hydroxyl bonds to a reactant; and

applying an electromagnetic radiation to the hydroxyl bonds while the hydroxyl bonds are exposed to the metal-containing reactant, the radiation of a sufficient magnitude to excite undesirable bonds formed during the exposure of the hydroxyl bonds to the reactant.

- 12. (Withdrawn) The method of claim 11, wherein the reactant is an oxygen source
- 13. (Withdrawn) The method of claim 12, wherein the oxygen source is water.
- 14. (Withdrawn) The method of claim 11, wherein the reactant includes a metal selected from a group consisting of zirconium, titanium, aluminum, gallium, cesium, indium, hafnium, tantalum, praseodymium, niobium, scandium, lutetium, cerium and lanthanum.
- 15. (Withdrawn) The method of claim 11, wherein the electromagnetic radiation is applied by a tunable laser.
- 16. (Withdrawn) The method of claim 11, wherein the undesirable bonds are metal to metal bonds.
- 17. (Withdrawn) The method of claim 16, wherein the metal is selected from a group consisting of zirconium, titanium, aluminum, gallium, cesium, indium, hafnium, tantalum, praseodymium, niobium, scandium, lutetium, cerium and lanthanum.
- 18. (Withdrawn) The method of claim 11, wherein the undesirable bonds are metal to halide bonds.

- 19. (Withdrawn) The method of claim 11, wherein the film formed on the substrate is a metal oxide.
- 20. (Withdrawn) The method of claim 11, wherein the film formed on the substrate is a metal nitride.
- 21. (Original) A method, comprising: modifying undesirable bonds in an atomic layer deposition (ALD) formed film to an energy level greater than a ground state of the undesirable bonds; and exposing the film to a reactant.
- 22. (Original) The method of claim 21, wherein modifying the undesirable bonds comprises reducing the number of undesirable bonds on the film.
- 23. (Original) The method of claim 21, wherein modifying the undesirable bonds comprises minimizing the number of undesirable bonds on the film.

Respectfully submitted,

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